Supplier Name: Contact Info: Form/Declaration Type: Created on:

Texas Instruments Inc. (DUNS# 00-732-1904) ti.com/support Distribute - RoHS and IEC 62474 DB

Distribute - RoHS and 05/31/2022

Details for "LM336BZ-2.5/LFT7"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LM336BZ-2.5/LFT7		Level-NC-NC-NC	Ext-Mfg	LP 3	4.3x4.3x3.6	209.3

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level				
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm			
Bond Wire										
Precious Metals	Gold	7440-57-5	0.03064	100	1000000	0.014641	146			
Sub-Total			0.03064	100	1000000	0.014641	146			
Lead Frame										
Copper and Its Alloys	Copper	7440-50-8	95.897448	99.81	998100	45.824977	458250			
Copper and Its Alloys	Iron	7439-89-6	0.14412	0.15	1500	0.068868	689			
Copper and Its Alloys	Phosphorus	7723-14-0	0.038432	0.04	400	0.018365	184			
Sub-Total			96.08	100	1000000	45.91221	459122			
Lead Frame Plating										
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.01	100	1000000	0.004779	48			
Sub-Total			0.01	100	1000000	0.004779	48			
Mold Compound										
Other Inorganic Materials	Fused Silica	60676-86-0	22.46015	20	200000	10.732672	107327			
Other Inorganic Materials	Silica	7631-86-9	72.995488	65	650000	34.881184	348812			
Other Nonferrous Metals and Alloys	Metal Hydroxide	Trade Secret	1.684511	1.5	15000	0.80495	8050			
Other Plastics and Rubber	Carbon Black	1333-86-4	0.561504	0.5	5000	0.268317	2683			
Other Plastics and Rubber	Silicone	218163-11-2	7.299549	6.5	65000	3.488119	34881			
Thermoplastics	Epoxy	85954-11-6	7.299549	6.5	65000	3.488119	34881			
Sub-Total			112.300751	100	1000000	53.66336	536634			
Semiconductor Device										
Ceramics / Glass	Doped Silicon	7440-21-3	0.84756	100	1000000	0.40501	4050			
Sub-Total			0.84756	100	1000000	0.40501	4050			
Total			209.268951			100	1000000			

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

Important Part Information

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Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. Ti may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Ti and Ti suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/31/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products realso fully compliant with ADSL and the IEC 62747 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.